ACM3-5036-A1-CC-S Specification

1. Features and Application

This product is for 2.4/5 GHz Dual Band WiFi, 802.11 a/b/g/n, Zigbee, Bluetooth,…

2. Explanation of Part Number

AC	M3	-	5036	-	A1	-	CC	-	S	_
(1)	(2)		(3)		(4)		(5)		(6)	(7)

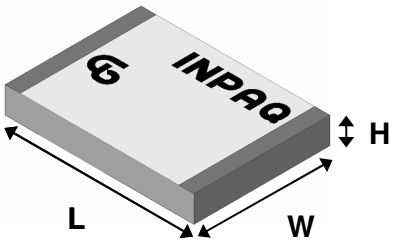
(1) Product Type: Chip Antenna
(2) Center Frequency/Band Code: 2.4/5 GHz Dual Band
(3) Size Code: 5.0*3.6 mm (Length*Width)
(4) Design Revision Code: Rev. 1
(5) Antenna Type: Coupling Ceramics
(6) Special Code: RoHS Compliant
(7) Suffix For Special Requirements

3. Electrical Specification

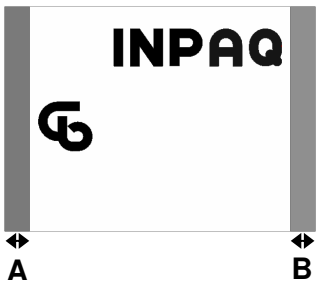
Item	Specification	
Frequency Band	2400 ~ 2500 MHz	5000 ~ 6000 MHz
Polarization	Linear	
Impedance	50 ohm Typ.	
VSWR	Less than 2.0	Less than 2.0
*Peak Gain	3.0 dBi Typ.	3.3 dBi Typ.
*Peak Efficiency	73.4% Typ.	80.2% Typ.

* Test condition: Test board size 80*40 mm
Matching circuit may be required

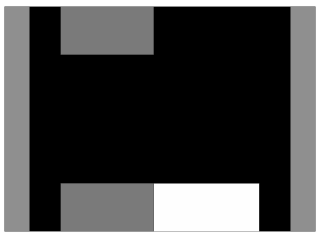
4. Physical Dimension



Top view



Bottom view



Marking is Black

(Unit: mm)

Chip Antenna	L	W	H	A	B
ACM3-5036-CC-A1	5.2±0.3	3.7±0.3	0.70±0.15	0.45±0.25	0.45±0.25

UNLESS OTHER SPECIFIED TOLERANCES ON : X=± X.X=± X.XX= ANGLES=± HOLEDIA=±		INPAQ TECHNOLOGY CO., LTD.	
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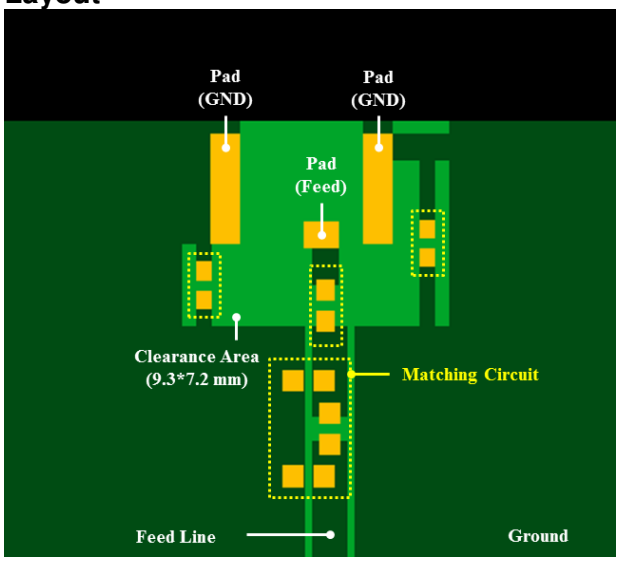
DRAWN BY : 趙彥年	CHECKED BY : 楊奇峯		
DESIGNED BY : 黃啓傑	APPROVED BY : 蘇志銘		
TITLE : ACM3-5036-A1-CC-S Specification		DOCUMENT NO.	ENS000062410	SPEC REV. P0

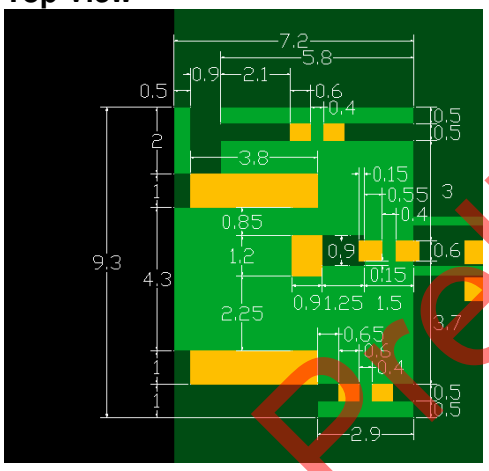
5. Recommend PCB Layout

Layout

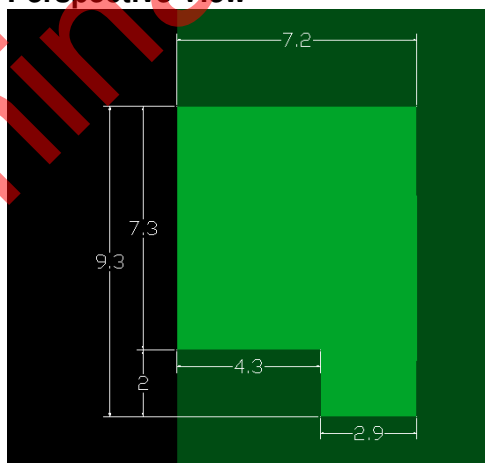


Pad Dimensions on PCB Layout

Top View



Perspective View



(Unit: mm)

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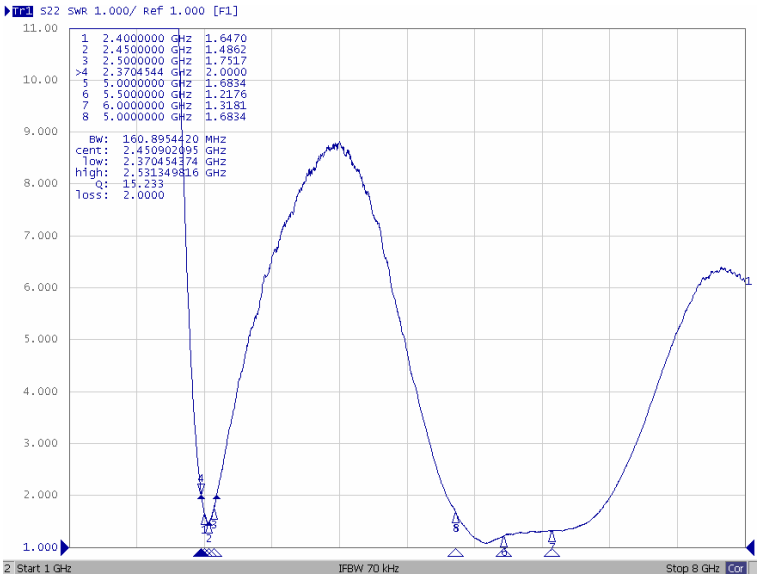
6. Electrical Characteristics

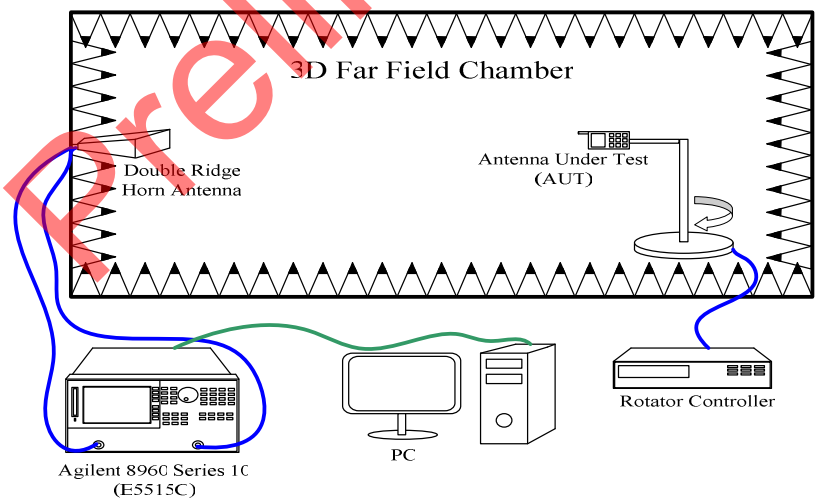
VSWR



Frequency (MHz)	VSWR
2400	1.7
2450	1.5
2500	1.7
5000	1.7
5500	1.2
6000	1.3

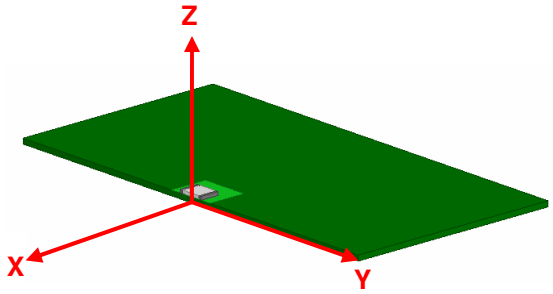
Radiation Pattern

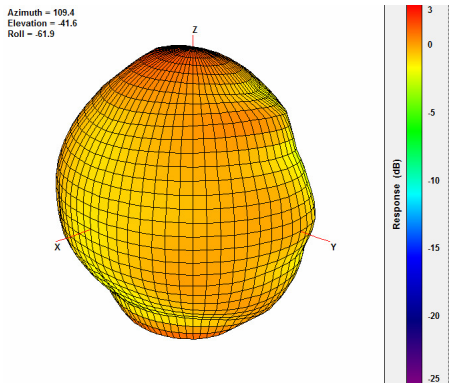
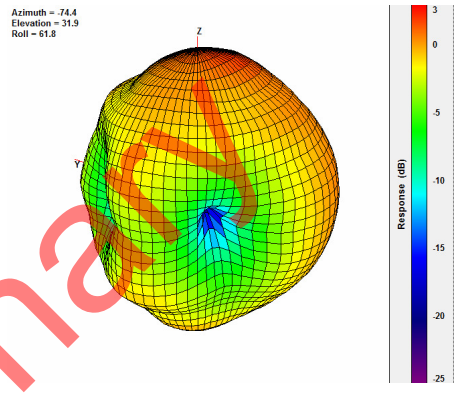
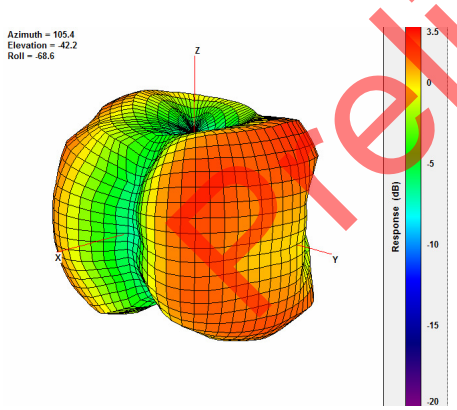
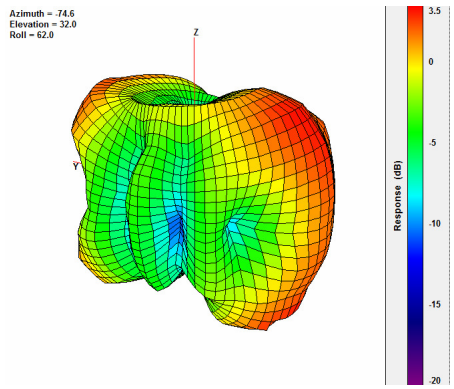
The Gain pattern is measured in INPAQ's FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.



3D Chamber Definition

3D Gain Pattern (2450 MHz)



2450 MHz	
	
5500 MHz	
	

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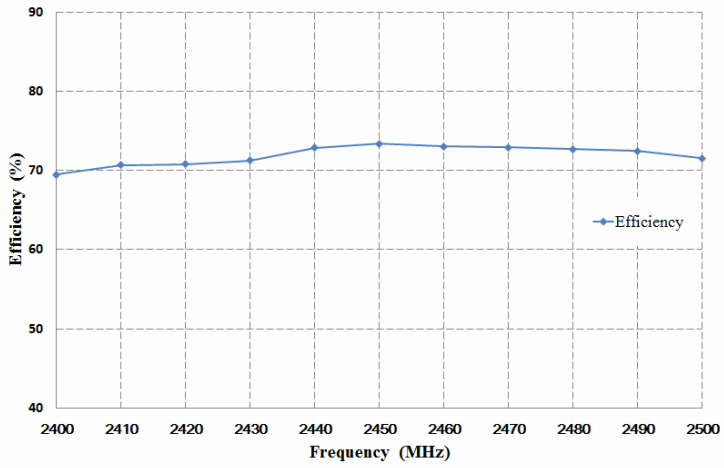
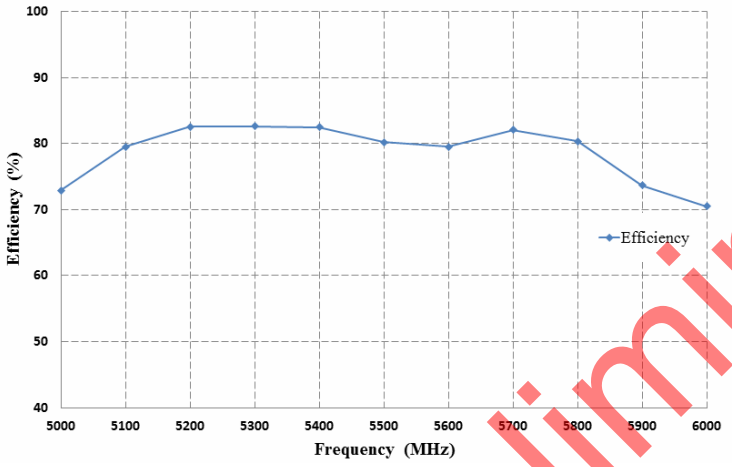
Efficiency



Frequency (MHz)	Efficiency (%)
2400	69.5
2450	73.4
2500	71.5
5000	72.9
5500	80.2
6000	70.5



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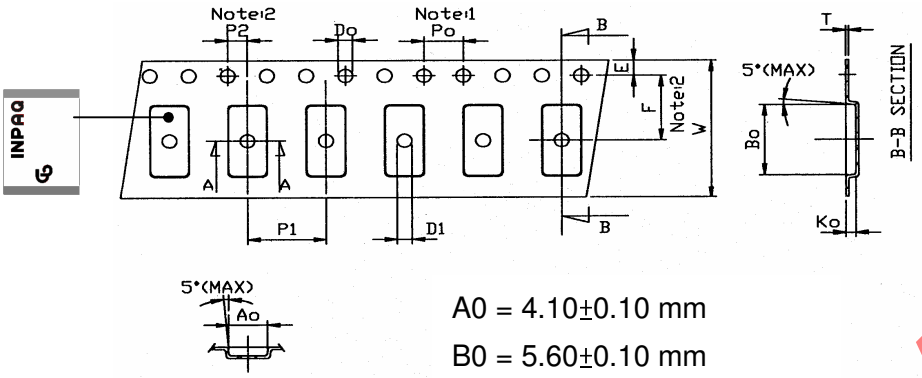
7. Taping Package and Label Marking

(1) Quantity/Reel: 2000pcs/Reel

(2) Carrier tape dimensions

(Unit: mm)

Symbol	Spec.
Po	4.00±0.1
P1	8.00±0.1
P2	2.00±0.05
Do	1.55±0.05
D1	1.50(MIN)
E	1.75±0.1
F	5.50±0.05
10Po	40.00±0.2
W	12.00±0.1
T	0.25±0.05



A0 = 4.10±0.10 mm

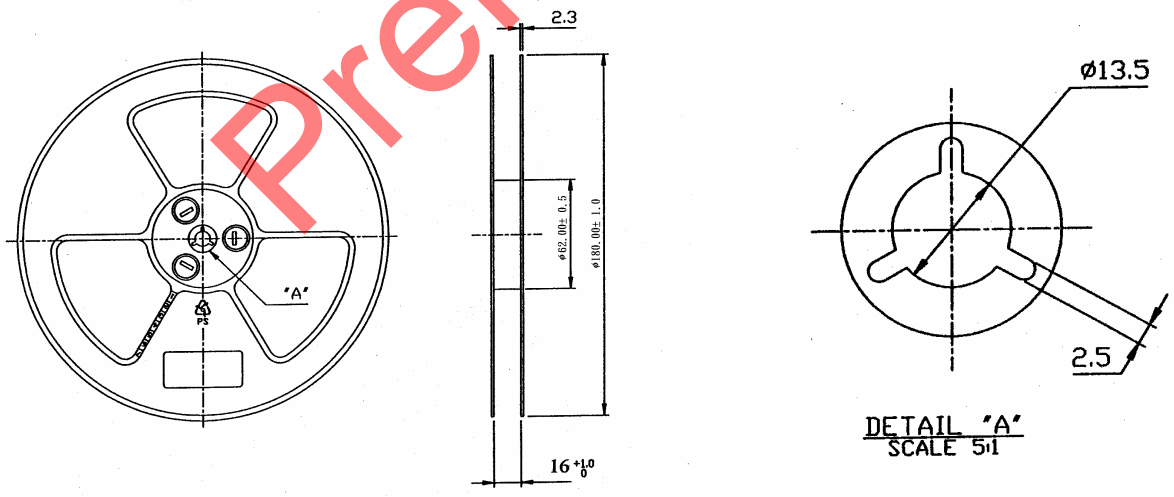
B0 = 5.60±0.10 mm

K0 = 1.02±0.10 mm

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is ±0.1mm
2. Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
3. Ao & Bo measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.
4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.

(3) Taping reel dimensions



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8. Environmental Characteristics

(1) Reliability Test

Item	Condition	Specification
Thermal shock	1. 30±3 minutes at -40℃±5℃, 2. Convert to +105℃ (5 minutes) 3. 30±3 minutes at +105℃±5℃, 4. Convert to -40℃ (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: 85±5℃ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: 150℃±5℃ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: -40℃±5℃ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature: 260±5℃ 2. Bathing time: 10±1 seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of 245±5℃ for 3±1 seconds.	No apparent damage

(2) Storage condition

(a) At warehouse:

The temperature should be within 0 ~ 30℃ and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

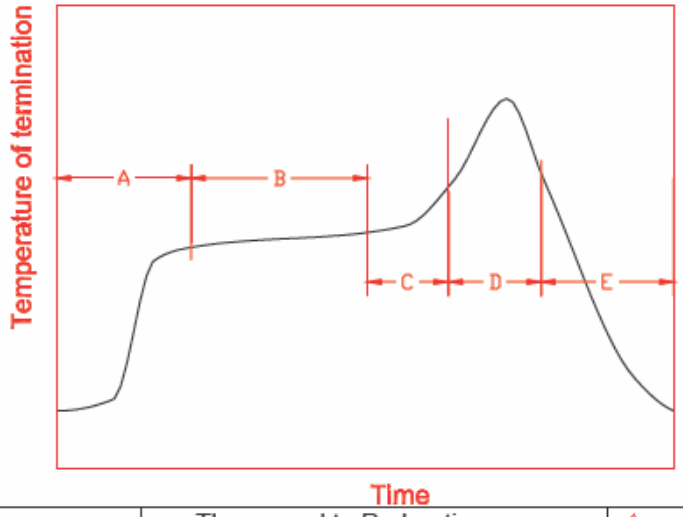
(b) On board:

The temperature should be within -40 ~ 85℃ and humidity should be less than 85% RH.

(3) Operating temperature range

Operating temperature range: -40 ~ +105℃.

9. Recommended reflow soldering



A	1st rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140℃ to 160℃	60s to 120s
C	2nd rising temperature	Preheating to 200℃	20s to 40s
D	Main heating	if 220℃	50s～60s
		if 230℃	40s～50s
		if 240℃	30s～40s
		if 250℃	20s～40s
		if 260℃	20s～40s
E	Regular cooling	200℃ to 100℃	1℃/s ～ 4℃/s

(1) Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

(a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.

(b) The soldering gun tip shall not touch this product directly.

(2) Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.